



Features

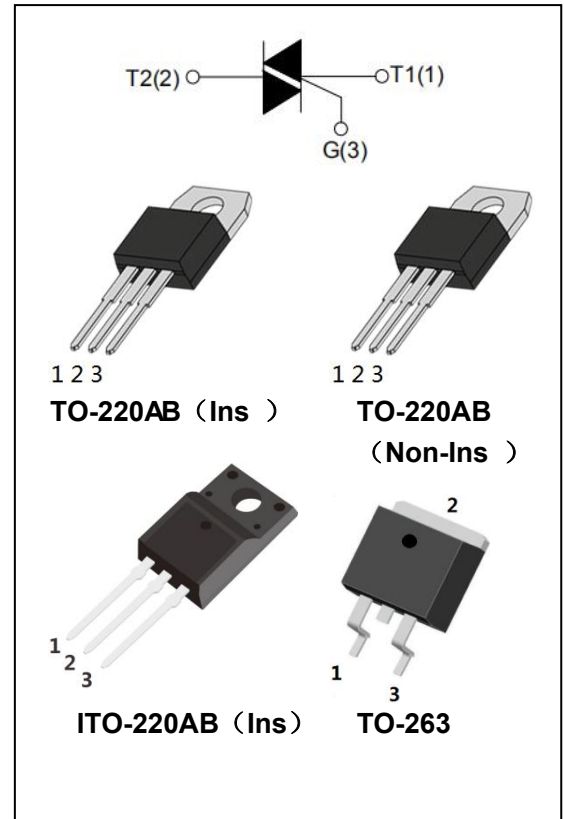
- ◇ The LGE BTA20/BTB20, 20A III & IV quadrants series triacs, which can be operated in III & IV quadrants. As silicon bidirectional device, with NPNPN five-layer structure; singesided trenching technology, mesa glass passivation process;
- ◇ multi-layer metallized electrode on the back side;
- ◇ High blocking voltage and high temperature stability.

Applications

The LGE BTA20/BTB20 is suitable for inductive load switching operations, also can be used in ON/OFF function applications such as washing machine, induction motor starting circuits, vacuum cleaners, power tools and other motors such as speed control maker; heating regulation, solid state relay; phases control circuit; AC motor speed regulation, and so on.

Mechanical Data

- ◇ Moisture Sensitivity: MSL Level 1, per J-STD-020
- ◇ Terminals: Matte Tin Finish.
Solderable per MIL-STD-202 Method 208
- ◇ Case Material: Molded Plastic;
- ◇ Molding compound meet UL Flammability
Classification Rating 94V-0
- ◇ Case: JEDEC TO-220AB, ITO-20AB, TO-263



MAXIMUM RATING

Ratings at 25°C ambient temperature unless otherwise specified.

PARAMETER			SYMBOL	VALUE	UNITS
R.M.S. On-State Current	BTA	Tc=80℃	I _{T(RMS)}	20	A
	BTB	Tc=90℃			
Non-Repetitive Surge Peak On-State Current(fFull Cycle,Tj initial=25℃)	F=50HZ	T=20ms	I _{TSM}	200	A
	F=60HZ	T=16.7ms		210	
I ² t Value for Fusing	tp=10ms		I ² t	200	A ² s
Critical Rate of Rise of On-State Current I _G =2×I _{GT} , tr≤100ns	F=120HZ	Tj=125℃	di/dt	50	A/ μ s
Repetitive peak Off-State voltage		Tj=25℃	V _{DRM} /V _{RRM}	600/800/1200	V
Non repetitive surge peak off-state voltage	tp=10ms	Tj=25℃	V _{DSM} /V _{RSM}	V _{DRM} /V _{RRM} +100	V
Peak Gate Current	tp=20μs	Tj=125℃	I _{GM}	4	A
Average Gate Power Dissipation		Tj=125℃	P _{G(AV)}	1	W
Typical Thermal Resistance (Junction to Ambient)	TO-220AB/TO-220ABins		R _{θJA}	60	℃/W
	TO-263			45	
Typical Thermal Resistance(Junction to Case (AC))	TO-220AB/TO-263		R _{θJC}	1.25	℃/W
	TO-220AB Insulated			2.10	
Maximum Operating Junction temperature			T _J	-40~+125	℃
Storage temperature range			T _{STG}	-40~+150	℃

ELECTRICAL CHARACTERISTICS(III QUADRANTS)

PARAMETER	TEST CONDITIONS	Symbol	VALUES					Units
				TW	SW	CW	BW	
Gate Trigger Current	$V_D=12V, R_L=100\Omega$	I_{GT}	MAX	5	10	35	50	mA
Gate Trigger Voltage	(I II IIIquadrant)	V_{GT}	MAX	1.5				V
Gate Non-Trigger Voltage	$T_j=125^\circ C$ (I II IIIquadrant)	V_{GD}	MIN	0.2				V
Holding Current $I_T=0.5A$		I_H	MAX	10	15	50	60	mA
Latching Current $I_G=1.2I_{GT}$	I III quadrant	I_L	MAX	10	25	60	70	mA
	II quadrant		MAX	20	30	70	90	
Critical Rate of Rise of Off-State Voltage $V_D=2/3V_{DRM}, T_j=125^\circ C$		dv/dt	MIN	15	100	500	1000	V/ μs
Critical Rate of Rise of Off-State Voltage at Commutation, $T_j=125^\circ C$		$(dv/dt)_c$	MIN	8.5	8.5	10	10	V/ μs

ELECTRICAL CHARACTERISTICS(IV QUADRANTS)

PARAMETER	TEST CONDITIONS		SYMBOL	VALUE			UNITS
					C	B	
Gate Trigger Current	VD=12V,RL=100 Ω (I II IIIIV quadrant)	I II III	IGT	MAX	25	50	mA
		IV		MAX	50	70	
Gate Trigger Voltage		All	VGT	MAX	1.5		V
Gate Non-Trigger Voltage	Tj=125°C (I II IIIquadrant)		VGD	MIN	0.2		V
Holding Current I _T =0.5A			I _H	MAX	40	60	mA
Latching Current =1.2I _{GT}	I III IVquadrant		I _L	MAX	50	70	mA
	II quadrant			MAX	70	90	
Critical Rate of Rise of Off-State Voltage V _D =2/3V _{DRM} ,Tj=125°C			dv/dt	MIN	200	500	V/ μ s
Critical Rate of Rise of Off-State Voltage at Commutation, Tj=125°C			(dv/dt) _c	MIN	5	10	V/ μ s

STATIC CHARACTERISTICS

PARAMETER	TEST CONDITIONS	SYMBOL		VALUE	UNITS
Peak On-State Voltage	$I_{TM}=28A, T_j=25^\circ C$	V_{TM}	MAX	1.55	V
Threshold Voltage	$T_j=125^\circ C$	V_{TO}	MAX	0.85	V
Dynamic Resistance	$T_j=125^\circ C$	R_d	MAX	21	m Ω
Repetitive Peak Off-Statte Curren $V_{DRM}=V_{RRM}$	$T_j=25^\circ C$	I_{DRM}/I_{RRM}	MAX	5	μA
	$T_j=125^\circ C$	I_{DRM}/I_{RRM}	MAX	2	mA

RATING AND CHARACTERISTICS CURVES

FIG.1: Maximum power dissipation versus RMS on-state current

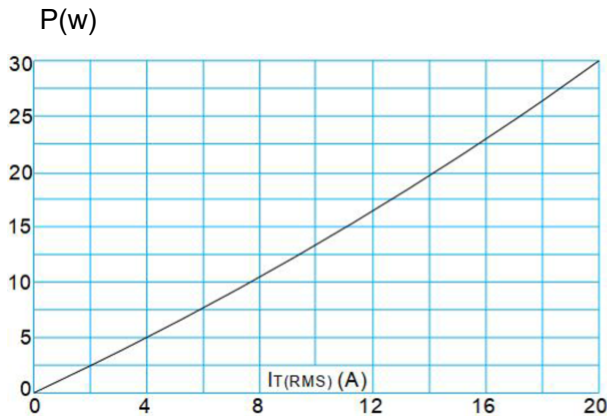


FIG.3: Surge peak on-state current versus number of cycles

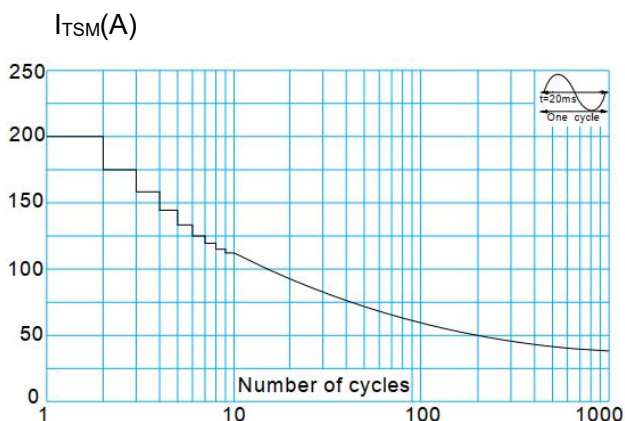


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 20ms$, and corresponding value of I^2t (I - II-III: $dI/dt < 50A/\mu s$; IV: $dI/dt < 10A/\mu s$)

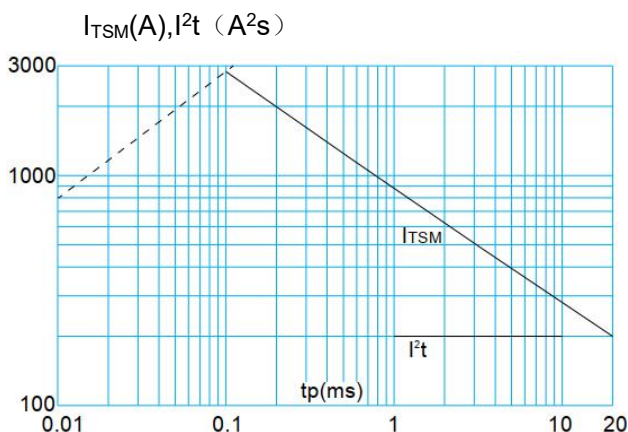


FIG.2: RMS on-state current versus case temperature

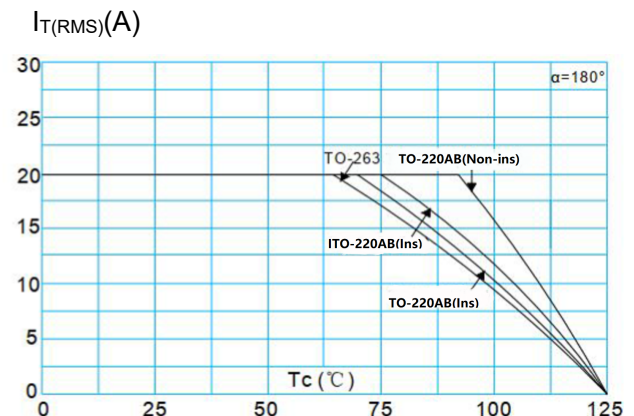


FIG.4: On-state characteristics (maximum values)

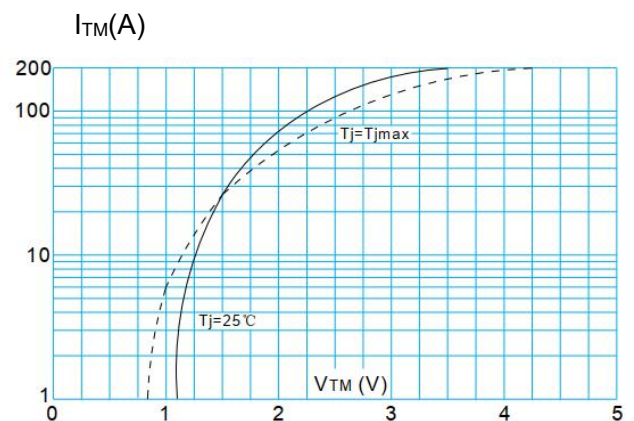
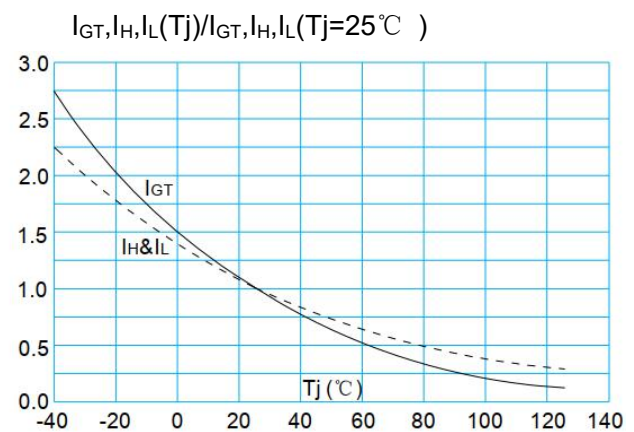
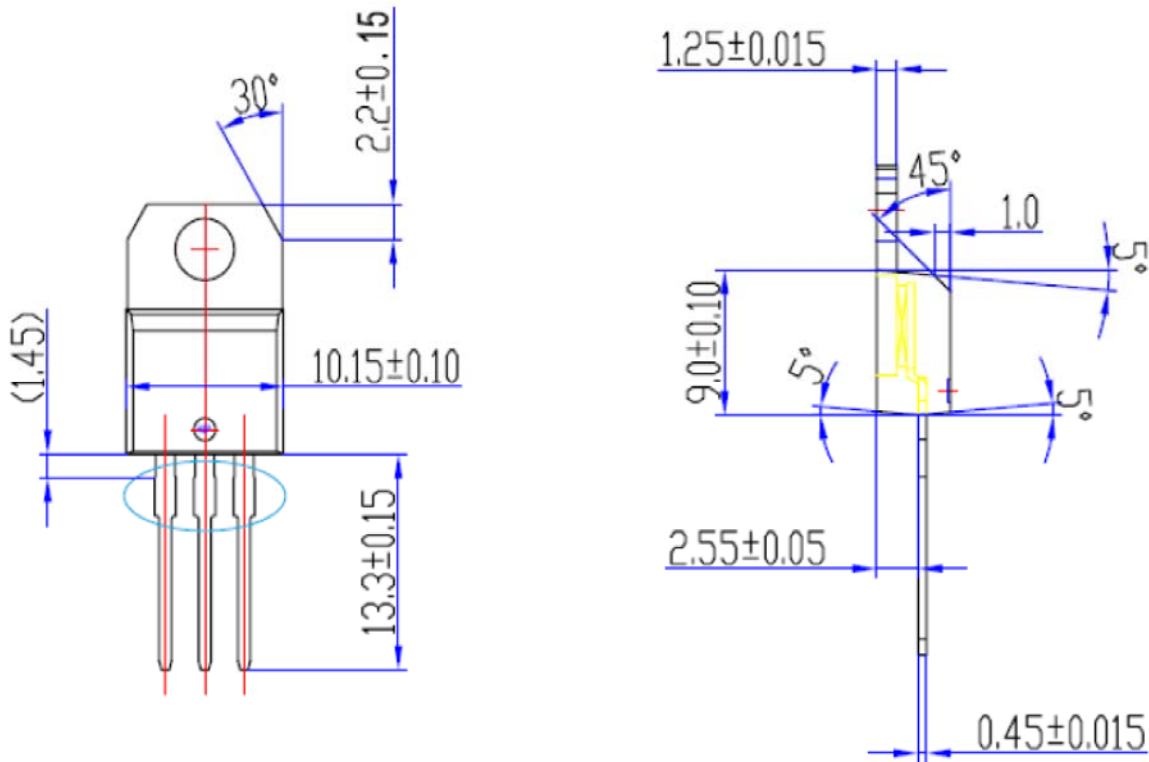


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature

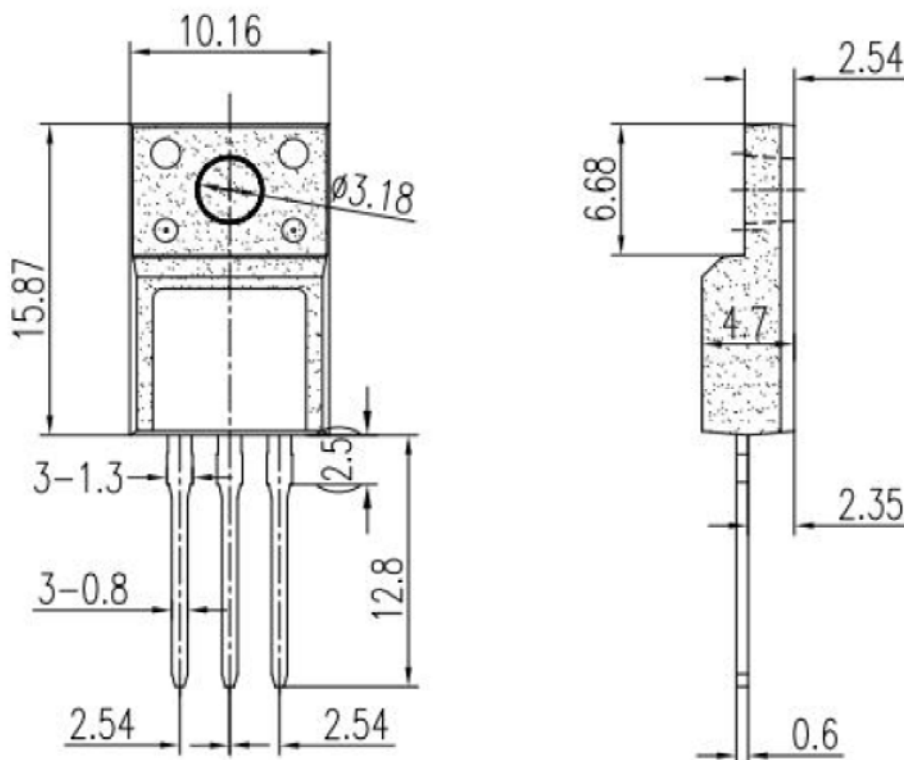


PACKAGE OUTLINE DIMENSIONS

TO-220AB units:mm

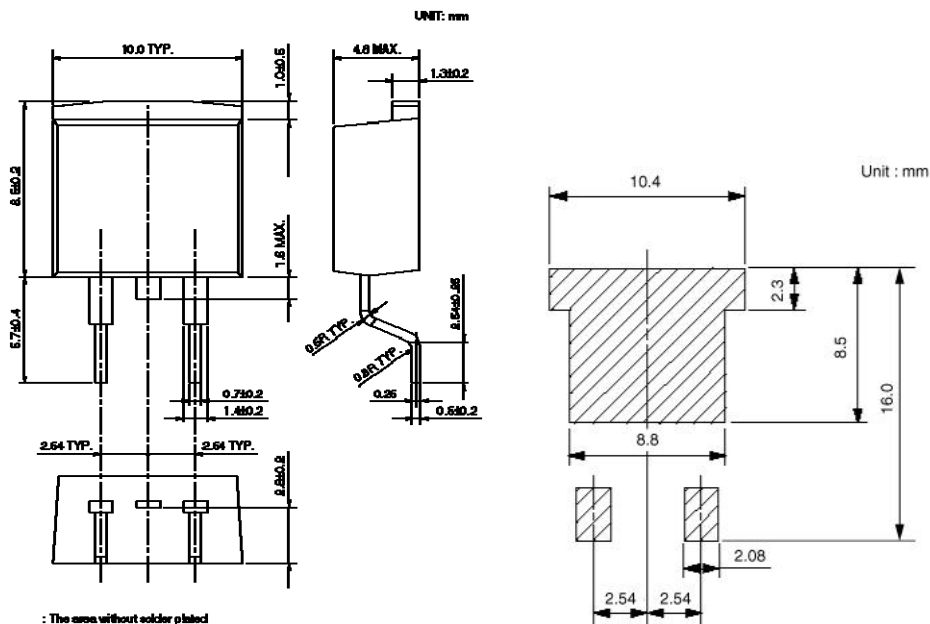


ITO-220AB units:mm(± 0.10)



PACKAGE OUTLINE DIMENSIONS

TO-263 units:mm(± 0.10)



ORDERING INFORMATION

	BT	A	20-	800	B
Triac					
Insulation					
A=Insulated					
B=Non-insulated					
Current					
20=20A					
Voltage					
600=600V					
800=800V					
Sensitivity and Type					
B=50mA					
C=25mA					
SW=10mA					
BW=50mA					
CW=35mA					
TW=5mA					